Electronic Patent Application Fee Transmittal

Application Number:	10680664
Filing Date:	07-Oct-2003
Title of Invention:	INTEGRATED CIRCUIT PACKAGE BOND PAD HAVING PLURALITY OF CONDUCTIVE MEMBERS
First Named Inventor/Applicant Name:	Yian-Liang Kuo
Filer:	David M. Odell/Lydia Epps-Hilliard
Attorney Docket Number:	24061.43 (TSMC2002-0978)

Filed as Large Entity

Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD($)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD($)
Extension-of-Time:				
Miscellaneous:				
			Total in USD ($)	**1740**